

# HSP

NOTES:  
 Current Rating: 0.75AMP  
 Contact Resistance: 20mΩ Max  
 Withstand Voltage: 500V AC/DC  
 Insulation Resistance: 1000MΩ Min  
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze  
 Contact plating: Au or Sn over Ni  
 Insulator Material: PA6T+30%GF UL94V-0

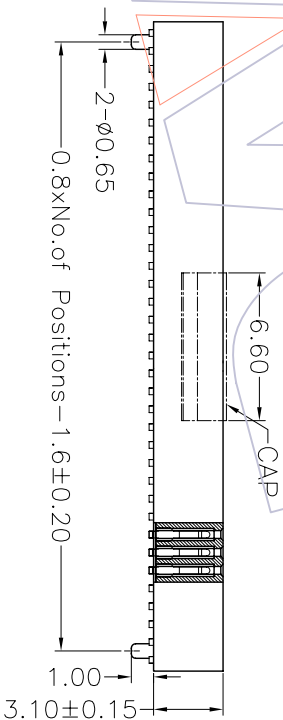
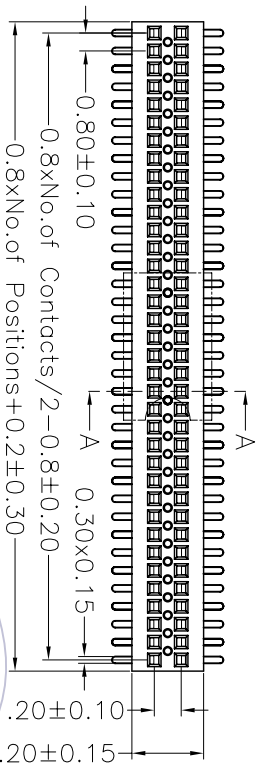
## Ordering Information

2631-2 XX M XX CTN X X

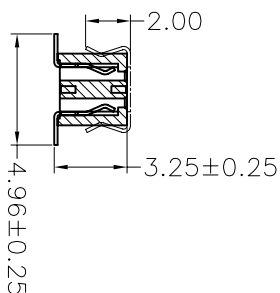
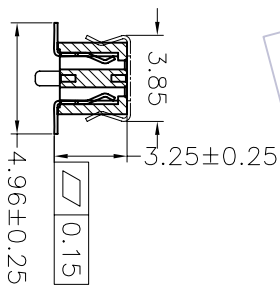
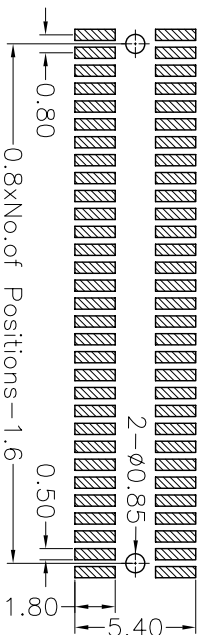
No. of Pins per Row: 02-50Pm  
 Contact Plating:  
 G0=Gold Flash  
 G1=3u"Gold  
 G2=5u"Gold  
 G3=10u"Gold  
 G4=15u"Gold  
 G5=30u"Gold  
 S0=Gold Flash/Tin  
 S1=3u"Gold/Tin  
 S2=5u"Gold/Tin  
 S3=10u"Gold/Tin  
 S4=15u"Gold/Tin  
 S5=30u"Gold/Tin  
 SN=Tin

Packaging:  
 T=Tube  
 P=Tube+CAP  
 R=Tape&Reel+CAP

Series No.  
 1=Type 1  
 2=Type 2



Recommended P.C.B Layout(Top Side)  
 (PCB BOARD TOLERANCE±0.05)



SECTION: A-A

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	WEIXD	SCALE	UNIT	PART NO.	TITLE:
A0	08/09/27	NEW			X.X ±0.40	DESIGN	08.09.27	3:1	mm	2631-2XXMXXCTNXX	PH0.80 DUAL ROW SMT H=3.10
					X.XX ±0.25	CHECK			A4		
					X.XXX ±0.15	APPROVE			1/1		
					Angle ± 3'				PROJ.	Customer NO.	

**WCON** 维峰五金电子有限公司  
 WAVE HARDWARE ELECTRONICS CO.,LTD